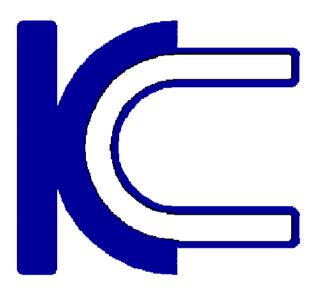
KING CORE ELECTRONICS INC.



Your Best EMI Solution Partner

A Company with Health, Happiness and Prospect





- Date of Establishment: Nov. 29, 1986.
- Location: Taiwan Taoyuan, 162,000 ft² (13,700M²)

China Suzhou, 614,000 ft² (56,700M²)

- Capital: USD 31.5 M. (2021/9/30)
- President: Henry Yang
- General Manager: Jonas Tsai
- Employees: ~500 Persons







COMPANY HISTORY

- → 1986: Established to produce ferrite cores
- → 1995: The second factory established to produce SMT multilayer chip beads / inductors.
- **→** 1996 : **ISO** 9000 certificated
- → 1999: Foundation Laying of King Core Suzhou C
- → 2001: To be listed company on OTC (Stock Code
- → 2003: The third factory established to produce SM
- → 2006: To be listed company on TWSE
- → 2008: ISO 14000 certificated
- → 2009: To be SONY Green Partner
- → 2009: IECQ QC080000 certificated
- **→** 2012 : TS16949 certificated
- → 2013: To invest in developing GHz filter
- → 2014: To invest in developing mini power choke / 1
- → 2016: Solar Power Generation at Pingjhen site: 417.6KV
- → 2017: To invest in developing LTCC BPF, LPF, Diplexer
- → 2019: To invest in developing Large Size Ferrite Core for E-Car/Bus
- → 2020: To invest in developing Inductive Antenna







AWARD & HONOR

- 1997: The first computerized ferrite factory in Taiwan and also the example factory by government Taiwan Small and Medium Enterprise Administration Ministry of Economic Affairs.
- 1999: Awarded "the Rising Star" by Government the best Medium and small enterprises.
- 2000: Been Awarded "The Achievement Price of Industrial Pollution Prevention and Waste Control" by Ministry of Economic Affairs, ROC
- 2000 : Been Awarded "The Best Center-satellite Factory of Environment Management" by Compal Computer Corp.
- 2001 : KC's Founder and President, Mr. Yang, been awarded "24th Annual Models of Chinese Youth Entrepreneur"
- 2002 : Been awarded by Asus Computer Inc as the "2001 the Best Cooperative Supplier"
- 2002: Been selected by Global Views Monthly as the 24th Best-Performance Company in Info Tech Top 200 of Taiwan
- 2005 : Been selected by Deloitte as the Top 500 of Asia Tech. company
- 2007~2020: Hitachi best performance vendor award.
- 2019~2021: The National Health Administration of the Ministry of Health and Welfare issued [Healthy Workplace Certification and Health Care Start Mark]



2021/12/15 4



MAIN PRODUCTS

EMI Suppression Ferrite Cores

• 600 tons

SMT Multilayer Chip Beads & Ind

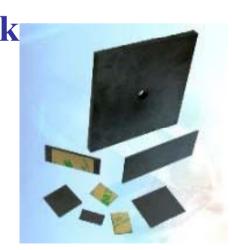
• 400~600 kkpcs (0402/0603)

Wound Chip inductor & Chok

• 150~200 kkpcs

Ferrite Absorber

• 2 kkpcs/ month



SMT Ferrite Chip

Beads / Inductors

TING CORE

2021/12/15

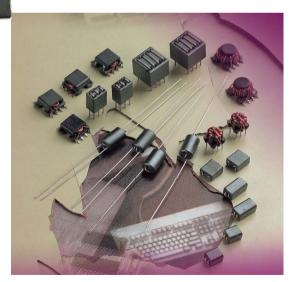
s inc.



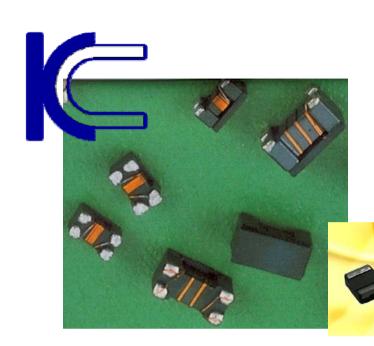






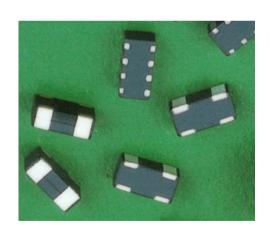










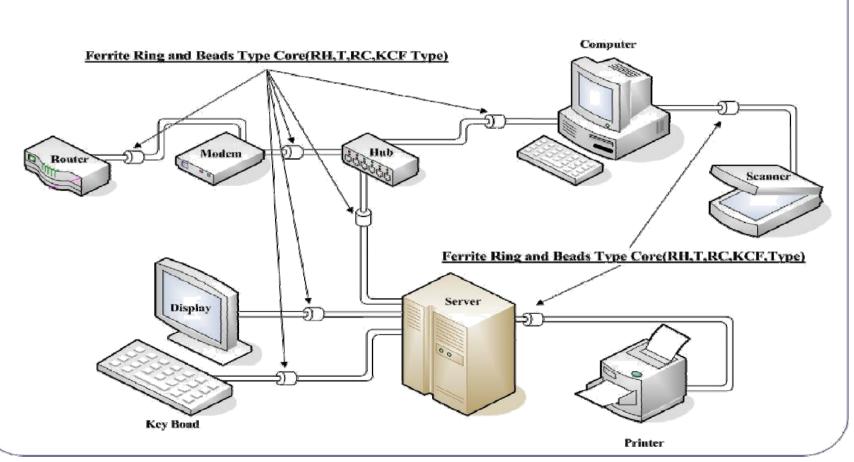






KC EMI Suppression Core Application

An Illustration of How to Apply EMI Ferrite Core on Cable







可:採用FBM-10 series

70 - 220 ohm bead

IC 電源 Vcc+ in之對策 可:採用FBM...A series

可:採用FBM-10 series

10 - 70 ohm bead

耐大電流 120 ohm bead

DC in 電源input之對策

可:採用FBM...A series 耐大電流 120 ohm bead

Clock Generator 之I對策

可:採用FBM-10 series 10 - 70 ohm bead

> IEEE 1394 or USB or LAN 介面之EMI對策 可:採用WCM series 90-220 ohm common choke

IC Grounding 接地之對策

可:採用FBM-11 series 120 - 600 ohm bead

2021/12/15

對策

可:採用FBM-11 series 600 - 1000 ohm bead

Print Port介面之EMI 新策

可:採用FBM-11 series 70 - 300 ohm bead

Video out or LVDS介面之 EMI對策

可:採用FBM-10 series 30 - 120 ohm bead



HDD or CD-ROM介面之 EMI對策

可:採用FBM-10 series 10 - 70 ohm bead





9





Proportion of Product Type

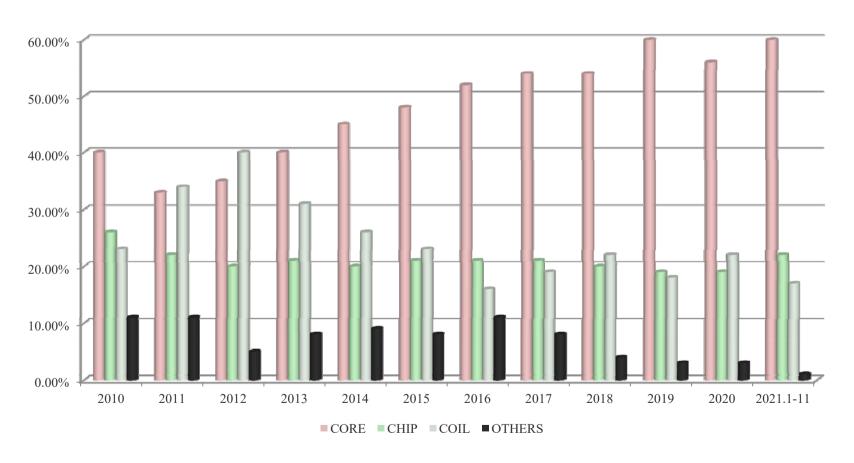
2021.1~11

CORE: 60%

CHIP: 22%

COIL: 17%

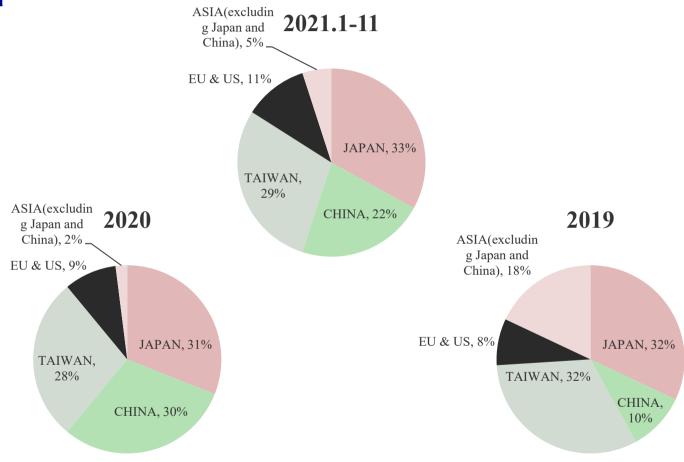
OTHERS: 1%







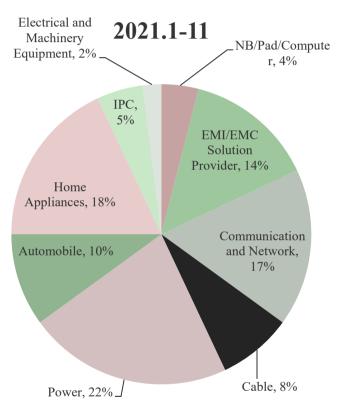
Proportion of Customer Area

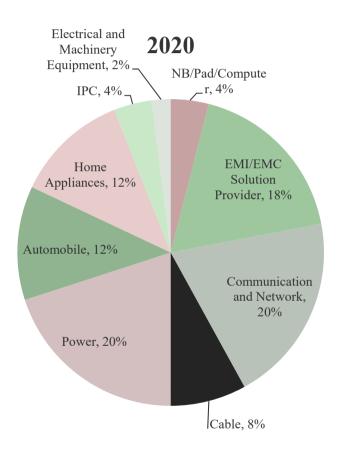






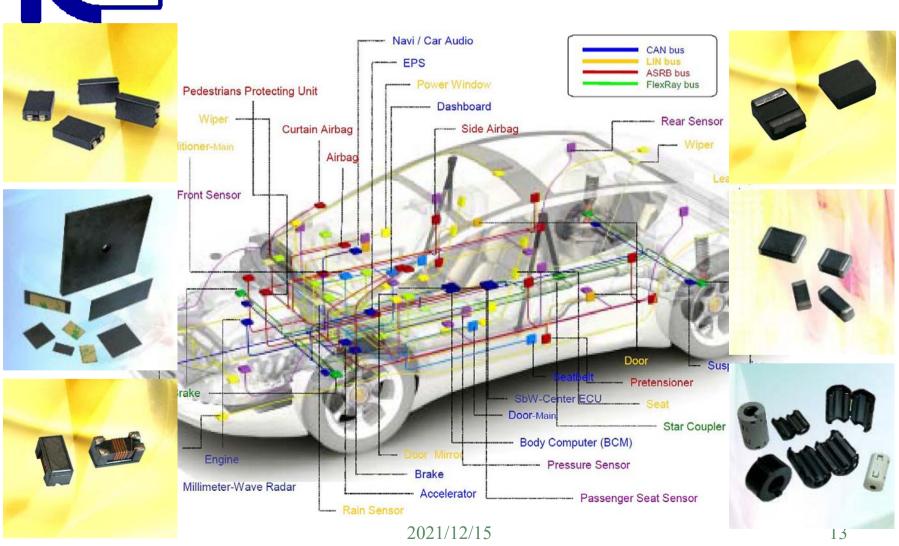
Proportion of Customer Application



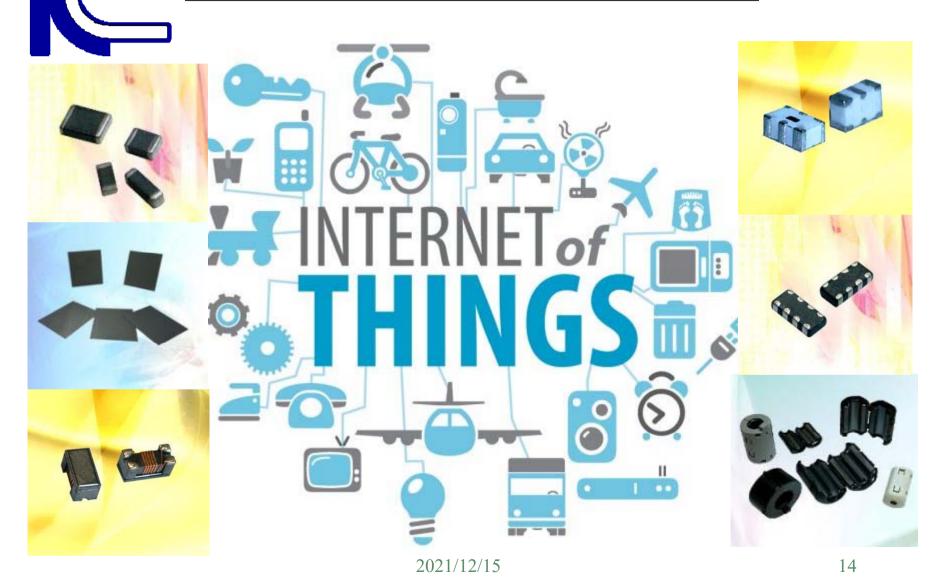




Automobile Electronics Application



Communication and Network Application





Home Appliances and IPC

















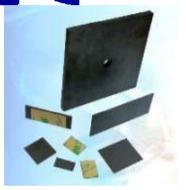




2021/12/15



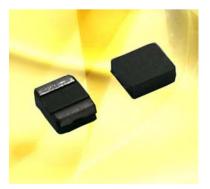
Power Application













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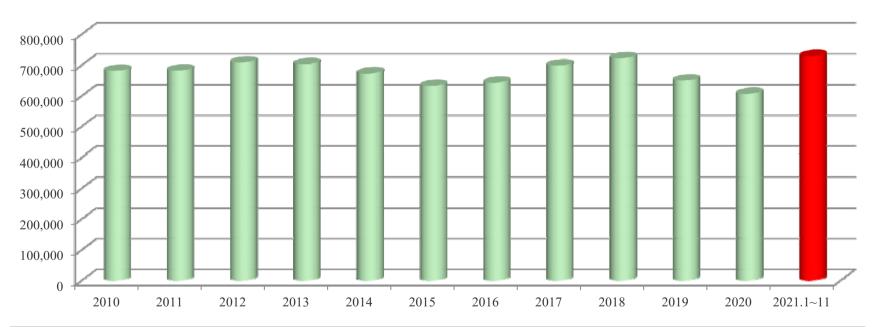


Turnover over the years

2021.1~11: 729,218

 $Y_0Y: +33\%$

Sales Amout



	2015	2016	2017	2018	2019	2020	2021.1~11
Sales Amount	632,332	642,745	698,467	722,186	649,900	606,740	729,218



Turnover proportion in Taiwan and Suzhou



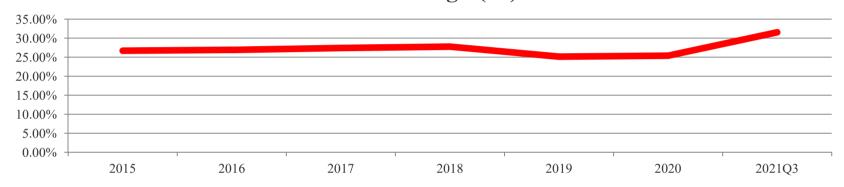
	2015	2016	2017	2018	2019	2020	2021Q3
Taiwan	82%	78%	78%	85%	80%	81%	79%
China	18%	22%	22%	15%	20%	19%	21%





Performance

Gross Margin(%)



Unit: NTD, K

	2015	2016	2017	2018	2019	2020	2021Q3
Net Revenue	632,332	642,745	698,467	722,186	649,900	606,740	590,329
Gross Profit	168,718	172,964	191,501	200,491	163,313	153,991	186,218
Gross Margin(%)	26.68%	26.91%	27.42%	27.76%	25.13%	25.38%	31.54%
Profit before tax	122,163	98,105	43,480	158,602	96,436	40,159	68,001
Profit for the period	104,086	82,557	42,957	127,497	80,341	34,073	52,780
ROE(%)	7.05	5.8	3.11	9.24	5.66	2.43	3.77
EPS (NT Dollar)	1.22	0.96	0.5	1.48	0.93	0.39	0.61

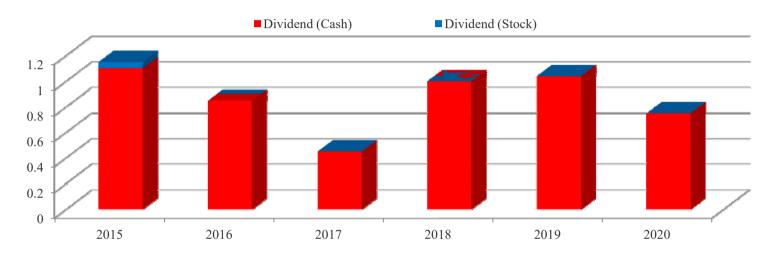
Note 1: Above financial information has been audited by CPA.

Note 2: Adopting International Financial Reporting Standards since year 2013.





Dividend



	2015	2016	2017	2018	2019	2020
Basic earnings per share (NT Dollar)	1.22	0.96	0.5	1.48	0.93	0.39
Dividend (Cash)	1.1	0.85	0.45	1.0	1.04	0.75
Dividend (Stock)	0.05	0	0	0	0	0
Dividend (Total)	1.15	0.85	0.45	1.0	1.04	0.75
Payment ratio	94.26%	88.43%	90.27%	67.68%	111.83%	192.31%

Note: Employee bonus as expenses since year 2008.

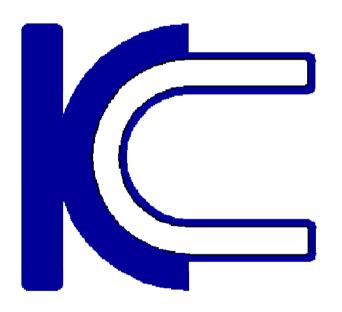


KC Product Development Roadmap

Product Target	Major Knowhow	Market Application		
GHz Common Mode Filter / Choke	Precision and patent LTCC design and manufacturing	5G, Ultra-high speed differential signal interface such as Common Mode, BPF, LPF and Diplexer		
GHz impedance suppression component in Multilayer chip design and material	Material composition, inner circuit design, precision printing technique	5G, GHz chip suppressor for EMI/RFI solution application		
EMI suppression absorber ferrite material	Material composition, pressing technique, sintering technique	Automotive Electronics, 5G, NFC, WPC, EMI/RFI shielding tool, EMI suppression component		
Inductive Antenna	Material composition, inner circuit design, winding technique	Automotive Electronics, Smart Home, RFID, Security System wireless sensors application		
High current power choke	Material composition, inner circuit design, lamination & winding technique	Automotive Electronics, Miniaturization 3C product's EMI & high current power solution		



鈞寶電子工業股份有限公司 KING CORE ELECTRONICS INC.



Thanks for your attending

